FORM PTO-1595	06-14-2000	U.S. DEPARTMENT OF COMMERC
OMB No. 0651-0011 (exp.4/94) WSGH FORM 23 (rev. 01/2000)		Patent and Trademark Offic
To the Honorable Commissioner of Pate thereof.	101380361	attached original documents or copy
<ol> <li>Name of conveying party(ies) Sentaro Kobayashi</li> <li>Additional name(s) of conveying parattached? [] Yes [X] No</li> <li>3. Nature of conveyance:         <ul> <li>[X] Assignment [] Merger</li> <li>[] Security Agreement [] Classion</li> <li>[] Other</li> </ul> </li> <li>Execution Date: May 16, 2000</li> </ol>	rty(ies) Name: <u>A.K. Techn.</u> Street Address: <u>4</u> <u>S.</u> City: <u>Nagano-ken</u> Country: <u>JAPAN</u> Additional name(s	ess of receiving party(ies) ical Laboratory, Inc. <u>963-3, Ohazamilnamijo</u> <u>akaki-machi, Hanishina-gun</u> State: Zip ) & address(es) attached? [] Yes [X] No
If this document is being filed too application is: <u>May 16, 2000</u> A. Patent Application No.(s) <b>09/583798</b> Addition 5. Name and address of party to who correspondence concerning document be mailed:	B. Fatent No.(: onal numbers attached? [ ] Yes om 6. Total number (	s)
Weingarten, Schurgin, Gagnebin & Ten Post Office Square Boston, Massachusetts 02109 /2000 JSHABAZZ 00000196 09583798 :581 40.00 DP	<ol> <li>Total fee (37         [X] Enclosed         [] Authoriz</li> <li>8. Deposit accou</li> </ol>	ed to be charged to deposit account
<ol> <li>Statement and signature.</li> <li>To the best of my knowledge and be attached copy is a true copy of th Attorney name: Charles L. Gagneb Registration No. 25,467</li> </ol>	lief, the foregoing informati e original document. oin III	Son is true and correct and any Date: $3-3/00$

PATENT REEL: 010844 FRAME: 0179

## ASSIGNMENT

For value received, I, Sentaro Kobayashi , residing at c/o A.K. Technical Laboratory, Inc., 4963-3, Ohazaminamijo, Sakaki-machi, Hanishina-gun, Nagano-ken, Japan, hereby sell, assign, and transfer to A.K. Technical Laboratory, Inc., a corporation existing under the Laws of Japan, located at 4963-3, Ohazaminamijo, Sakaki-machi, Hanishina-gun, Nagano-ken, Japan, and its successors, assigns, and legal representatives, the entire right, title, and interest for all countries including the United States of America, in and to certain inventions relating to

## MOLD CLAMPING APPARATUS

described in an application for Letters Patent of the United States, executed by us on this date, and all patents which may be granted therefor, and all divisions, reissues, continuations and extensions thereof, and authorize and request the Commissioner of Patents to issue all patents on said improvements or resulting therefrom to said Company as assignee of the entire interest, and covenant that I have full right so to do, and agree that I will communicate to said Company or its representatives any facts known to us respecting said improvements and testify in any legal proceedings, sign all lawful papers, execute all divisional, continuing and reissue applications, make all rightful oaths and generally do everything possible to aid said Company its successors, assigns, and nominees, to obtain and enforce proper protection for said invention in the United States.

Signature <u>人,林 泉</u>

May 16 2000 Date Burgetayes x126x, x x200000

> PATENT REEL: 010844 FRAME: 0180

**RECORDED: 05/31/2000**